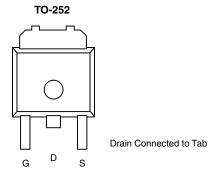


IRLR024NTRPBF-VB Datasheet N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A)	Q _g (Typ.)			
60	0.073 at V _{GS} = 10 V	18	19.8			
60	0.085 at V_{GS} = 4.5 V	15	19.0			



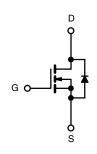
FEATURES

- Trench Power MOSFET
- 100 % R_g and UIS Tested
- Material categorization:
 For definitions of compliance please see

RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- DC/DC Converters
- DC/AC Inverters
- Motor Drives



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	60	V			
Gate-Source Voltage	V _{GS}	± 20	v			
Continuous Drain Current	T _C = 25 °C		18			
Continuous Drain Current	T _C = 70 °C	I _D	14	А		
Pulsed Drain Current (t = 300 µs)	I _{DM}	25				
Avalanche Current	I _{AS}	15				
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	11.25	mJ		
Maximum Power Dissipation ^a	T _C = 25 °C	Р	41.7 ^b	W		
	T _A = 25 °C ^c	P _D	2.1	V		
Operating Junction and Storage Tempe	erature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	60	°C/W		
Junction-to-Case (Drain)	R _{thJC}	3	0/11		

Notes:

a. Duty cycle ≤ 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).

d. Base on $T_C = 25$ °C.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		3.0	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50		
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$			250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	20			А	
Drain-Source On-State Resistance ^a	Б	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.6 \text{ A}$		0.073		Ω	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 6 \text{ A}$		0.085			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 6.6 A		25		S	
Dynamic ^b							
Input Capacitance	C _{iss}			660		pF	
Output Capacitance	C _{oss}	V_{DS} = 30 V, V_{GS} = 0 V, f = 1 MHz		85			
Reverse Transfer Capacitance	C _{rss}			40			
Total Gate Charge ^c	Qg			19.8	30	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.6 \text{ A}$		3.6			
Gate-Drain Charge ^c	Q _{gd}			4.1			
Gate Resistance	Rg	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	16		
Rise Time ^c	tr	$V_{DD} = 30 \text{ V}, \text{ B}_{L} = 9.6 \Omega$		11	20	-	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 5.2$ Å, $V_{GEN} = 10$ V, $R_g = 1 \Omega$		18	27		
Fall Time ^c	t _f			5	10		
Turn-On Delay Time ^c	t _{d(on)}			38	57	ns	
Rise Time ^c	tr	$V_{DD} = 30 \text{ V}, \text{ R}_{1} = 9.6 \Omega$		58	87	-	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 5.2$ Å, $V_{GEN} = 4.5$ V, $R_g = 1 \Omega$		18	27		
Fall Time ^c	t _f			8	16		
Drain-Source Body Diode Ratings a	nd Characteri	stics ^b T _C = 25 °C					
Continuous Current	۱ _S				18	^	
Pulsed Current	I _{SM}				25	A	
Forward Voltage ^a	V _{SD}	$I_F = 5.2 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.5	V	
Reverse Recovery Time	t _{rr}			34	51	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 5.2 A, dI/dt = 100 A/μs		3	5	Α	
Reverse Recovery Charge	Q _{rr}			50	75	nC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

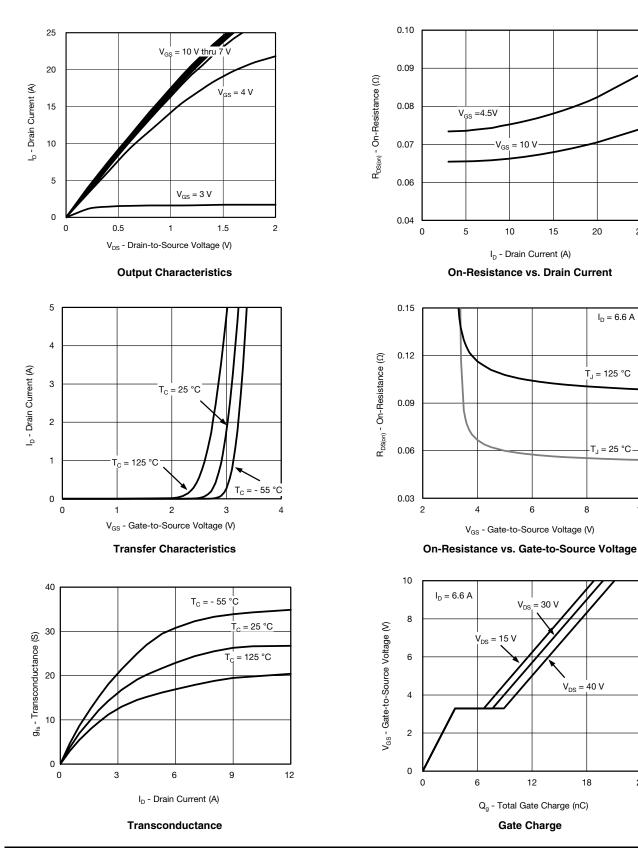
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25

10

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

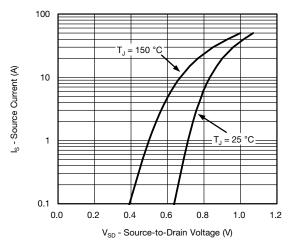


服务热线:400-655-8788

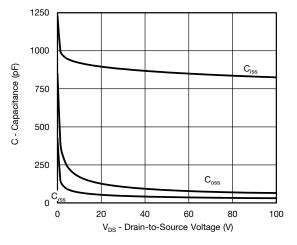
24



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



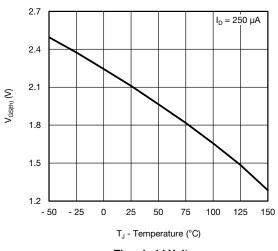
Source-Drain Diode Forward Voltage



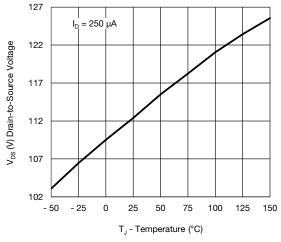




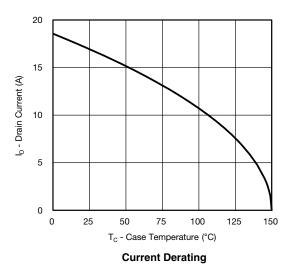
On-Resistance vs. Junction Temperature



Threshold Voltage

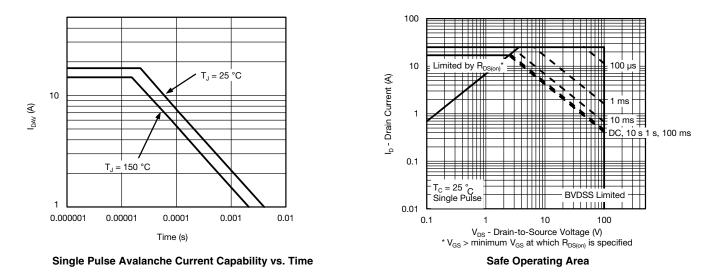


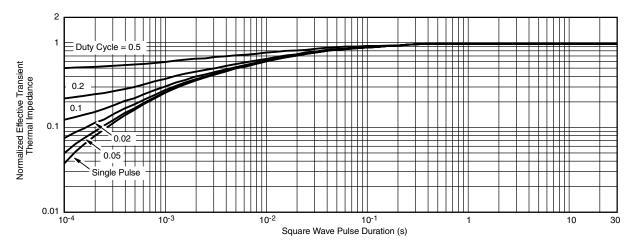
Drain Source Breakdown vs. Junction Temperature





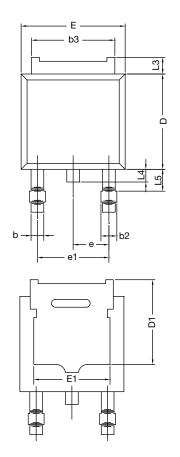
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



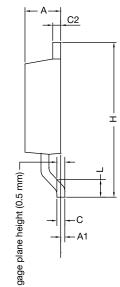


Normalized Thermal Transient Impedance, Junction-to-Case





TO-252AA Case Outline



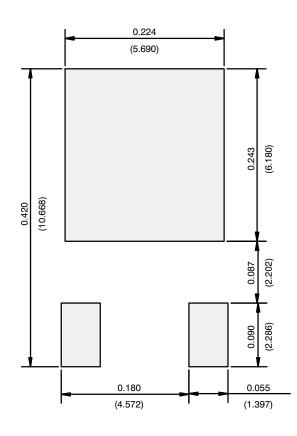
	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16 DWG: 5347					

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

IRLR024NTRPBF-VB



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